



ISAP 2018

2018 International Symposium on Antennas and Propagation
October 23(Tue.) ~ 26(Fri.), 2018 | Paradise Hotel, Busan, Korea

Sponsorship & Exhibition Prospectus

 www.isap2018.org





I. Greetings

On behalf of the Local Organizing Committees of ISAP 2018, it is my pleasure to invite you to the 2018 International Symposium on Antennas and Propagation (ISAP2018) which will be held during October 23~26, 2018 at Paradise Hotel Busan, Busan, Korea.

We hope to provide an excellent forum for interaction and developing friendships with participants who are involved in research, development, engineering, manufacturing, and applications of antennas and propagation from various countries.

We, the Local Organizing Committees of ISAP 2018, are delighted that ISAP will be held again in Korea after 2005 (Seoul) and 2011 (Jeju). We hope you would come and enjoy the Symposium in Busan, the top convention hosting city in Asia and also the international prestige tourism city.

I would like to offer great opportunities for you to support this symposium and showcase your professional services and innovative materials and equipment through sponsoring and exhibiting.

I hope you would take advantage of this opportunity to promote your products and services to global attendees of antennas and propagation in ISAP 2018.

Thank you very much.

Sincerely,

Prof. Jaehoon Choi

Symposium Chair of ISAP 2018
Professor of Hanyang University

Prof. Bomson Lee

President of KIEES
Professor of Kyung Hee University



II. Overview

Title	ISAP 2018 2018 International Symposium on Antennas and Propagation
Date	October 23(Tue.) ~ 26(Fri.), 2018
Venue	Paradise Hotel Busan, Busan, Korea
Attendees & Exhibits	600 Attendees and 20 Exhibits (Expected)
Organized by	The Korean Institute of Electromagnetic Engineering and Science (KIEES)
Technically Co-sponsored by	Institute of Electronics, Information and Communication Engineers Communications Society (IEICE-CS) Antennas and Propagation Society of the Institute of Electrical and Electronics Engineers (IEEE/AP-S) Antennas Society of CIE (CIE-AS) International Union of Radio Science (URSI) The Institute of Electronics and Information Engineers (IEIE) IEEE AP-S Seoul Chapter The Korean Institute of Communications and Information Science (KICS) The European Association on Antennas and Propagation (EurAAP) The European Conference on Antennas and Propagation (EuCAP) The Institution of Engineering and Technology Antennas and Propagation Technical Professional Network (IET) Institute of Antenna Engineers of Taiwan (IAET) The Radio Electronics Association of Vietnam (REV) Electrical Engineering/Electronics, Computer, Telecommunications and Information Technology (ECTI) Association
Website	www.isap2018.org
Contact Information	ISAP 2018 Secretariat Tel: +82-42-472-7460 Fax: +82-42-472-7459 E-mail: secretariat@isap2018.org

III. Program

	October 23 (Tue.)	October 24 (Wed.)	October 25 (Thu.)	October 26 (Fri.)
Morning	Registration	Opening Ceremony	Oral Session 3	Oral Session 6
		Plenary Talk 1	Coffee Break	Coffee Break
		Coffee Break	Plenary Talk 3	Oral Session 7
		Plenary Talk 2	Plenary Talk 4	Oral Session 7
Noon	Lunch	Lunch	Lunch	Lunch
Afternoon	Short Course	Oral Session 1	Oral Session 4	Poster Session
		Coffee Break	Coffee Break	Oral Session 8
		Student Paper Competition	Oral Session 5	
		Oral Session 2	Poster Session	
Evening	Welcome Reception		Banquet	





※ EurAPP (EuCAP) Special Sessions will be arranged.

※ Plenary: 4 Talks

Oral: 300 Papers

Poster: Maximum of 120 Papers simultaneously

Plenary Speakers

Name	Introduction
 <p>Dr. Hongbeom Jeon</p>	<p>[Korea]</p> <ul style="list-style-type: none"> ■ Subject: Vision of 5G and its technologies and services ■ Affiliation <p>- Executive Vice President, Infra Lab. KT</p>
 <p>Prof. William Scanlon</p>	<p>[United Kingdom]</p> <ul style="list-style-type: none"> ■ Subject: Antennas and Propagation Challenges and Considerations for Next Generation Biomedical Sensing and Therapeutic Applications ■ Affiliation <p>- Director of the Centre for Wireless Innovation (CWI) - Chair of Wireless Communications at Queen's University</p>
 <p>Prof. Yong Fan</p>	<p>[China]</p> <ul style="list-style-type: none"> ■ Subject: All Solid State Terahertz Circuits and Radar Systems ■ Affiliation <p>- Dean of School of Electronic Engineering, UESTC</p>
 <p>Dr. Yukihiro Okumura</p>	<p>[Japan]</p> <ul style="list-style-type: none"> ■ Subject: 5G Communication ■ Affiliation <p>- 5G Laboratory, NTT DOCOMO, INC., - Leader of 5G Trial Promotion Group in 5GMF</p>

IV. Sponsorship Information

Sponsorship Package [Type A]

Level	Value(KRW)	Benefits
Platinum	10,000,000	<ul style="list-style-type: none"> - 2 complementary registrations (including Conference Kit) - Speech opportunities during the banquet - 2 free exhibit booths (or 2 video systems) - Advertisement of the company on the program book (1 page / Color) - Logo and web link on the symposium website - Logo featured on the banner and signage
Diamond	7,000,000	<ul style="list-style-type: none"> - 1 complementary registrations (including Conference Kit) - Speech opportunities during the reception - 1 free exhibit booth (or 1 video system) - Advertisement of the company on the program book (1/2 page / Color) - Logo and web link on the symposium website - Logo featured on the banner and signage
Gold	5,000,000	<ul style="list-style-type: none"> - 1 complementary registrations (including Conference Kit) - 1 free exhibit booth (or 1 video system) - Advertisement of the company on the program book (1/2 page / Color) - Logo and web link on the symposium website - Logo featured on the banner and signage
Silver	3,000,000	<ul style="list-style-type: none"> - Advertisement of the company on the program book (1/2 page / Black & white) - Logo and web link on the symposium website - Logo featured on the banner and signage - 1 Conference Kit
Bronze	2,000,000	<ul style="list-style-type: none"> - Logo on the program book - Logo and web link on the symposium website - Logo featured on the banner and signage - 1 Conference Kit

※ 1 US Dollar = 1,063 KRW (exchange rates as of January 16, 2018)

Sponsorship Package [Type B]

Event	Value(KRW)	Benefits
Banquet	15,000,000	<ul style="list-style-type: none"> - 3 complementary registrations (including Conference Kit) - Company's Promotional video and speech opportunities during the banquet - 2 free exhibit booths (or 2 video systems) - Advertisement of the company on the program book (1 page / Color) - Logo and web link on the symposium website - Logo featured on the banner and signage - Company's promotional leaflet placed on the banquet site.
Welcome Reception	10,000,000	<ul style="list-style-type: none"> - 2 complementary registrations (including Conference Kit) - Company's Promotional video and speech opportunities during the reception - 2 free exhibit booths (or 2 video systems) - Advertisement of the company on the program book (1 page / Color) - Logo and web link on the symposium website - Logo featured on the banner and signage - Company's promotional leaflet placed on the reception site.
Conference Kit	5,000,000	<ul style="list-style-type: none"> - 1 complementary registrations (including Conference Kit) - Logo and web link on the symposium website - Logo on the program book - Logo on the lanyard.
Coffee Break	3,500,000	<ul style="list-style-type: none"> - Logo and web link on the symposium website - Logo on the program book - Set the X-banner in front of the coffee break site.

※ Type B offers special opportunities to promote your company during the events.

※ 1 US Dollar = 1,063 KRW (exchange rates as of January 16, 2018)



[Sponsorship Application Form]

Please fill-up this Application below and send to the Secretariat by August 31, 2018

■ **ISAP 2018 Local Secretariat**

273, Baeul 1-ro, Yuseong-gu, Daejeon, Korea (Zip code 34036)

Tel: +82-42-472-7460 / Fax: +82-42-472-7459 / E-mail: secretariat@isap2018.org

1. Registering company and person in charge

Company Name			
Website			
Address			
City		Postal code	
Country			
Telephone		Mobile	
E-mail		Fax	
Contact Person Name			
Job Title		Department	

2. Application (Please check(V) for your choice)

Category	
Type A	Type B
<input type="checkbox"/> Platinum	<input type="checkbox"/> Banquet
<input type="checkbox"/> Diamond	<input type="checkbox"/> Welcome Reception
<input type="checkbox"/> Gold	<input type="checkbox"/> Conference Kit
<input type="checkbox"/> Silver	<input type="checkbox"/> Coffee Break
<input type="checkbox"/> Bronze	

3. Payment Method (Bank Transfer Only)

Account Holder	Korean Institute of Electromagnetic Engineering and Science (KOR) (사)한국전자파학회
Account Number	208-017491-01-209
Bank Name	Industrial Bank of Korea
SWIFT Code	IBKOKRSE
Bank Address	50, Euljiro 2-ga, Jung-gu, Seoul, Korea

Date _____

Signature _____

V. Exhibition Information

(1) Introduction of Exhibition

1) Place: Capri Room and the foyer, Paradise Hotel Busan, Busan, Korea

2) Date & Time

No.	Detailed Schedule	Date	Time
1	Booths Assembling	October 23(Tue.)	6 pm to 11 pm
2	Decoration Period (Exhibitor)	October 24(Wed.)	7 am to 11am
3	Exhibition Period	October 24(Wed.)	9 am to 5 pm
		October 25(Thu.)	9 am to 5 pm
		October 26(Fri.)	9 am to 13 pm
4	Booths Dismantling	October 26(Fri.)	13 pm to 18 pm

3) Application Due: August 31, 2018

4) Price for the Exhibition Booth

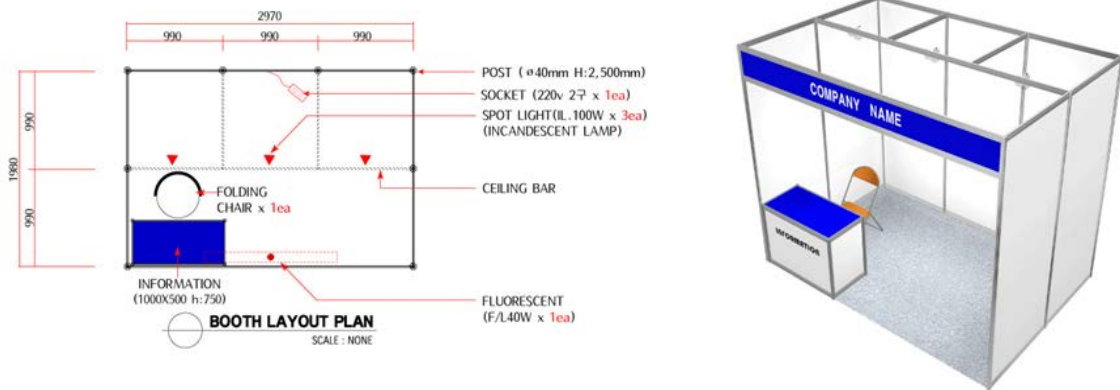
Category	Size (Per 1 booth)	Participation Fee
Standard	3m(W) * 2m(L) * 2.5m(H)	1 Stand = KRW 2,500,000 * <i>Exhibition Discounts are provided as shown below:</i> 2 exhibition registrations 5% 3 exhibition registrations 10% 4 exhibition registrations 15%

※ 1 US Dollar = 1,063 KRW (exchange rates as of January 16, 2018)

5) Benefits for the Exhibitors per 1 booth

- 1 exhibit booth (or 1 video system)
- 2 name tags (lunch coupons/day)
- 2 Conference Kits
- Logo and web link on the symposium website

6) Standard Shell Scheme Booth



- The booth will be built in Octanorm system, covered with panel in white color.
- Area: 3.00m Width X 2.00m Length X 2.5m Height
- Floor: The floor will be totally covered with Gray (or red) carpet, 2mm thick.
- Furniture: The booth will have 1 set of information desk with a chair built in Octanorm system, covered in white & blue color.
- Electric Outlet: 2 spots with 2 sockets / 220V

7) Allocation of booth

Allocation of booth will be on FIRST COME FIRST SERVE basis. The organizer shall position the booth after giving a due consideration of the order of applications received, type of products, floor space and other substantial standards. Exhibitors may not object to the decisions made by the organizer. Exhibitors shall not sublet or transfer all or part of the booth space, nor shall they exchange booths with other exhibitors. If this provision is violated, the organizing committee may dismiss the exhibitors from the show. The organizing committee reserves the right to rearrange or relocate the booths based on the actual number of booths sold. Decisions of the organizer are conclusive; claims by exhibitors regarding allocation of booths will not be taken into consideration.



[Exhibition Application Form]

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Tel: +82-42-472-7460 / Fax: +82-42-472-7459 / E-mail: secretariat@isap2018.org

1. Registering company and person in charge

Company Name			
Website			
Address			
City		Postal code	
Country			
Telephone		Mobile	
E-mail		Fax	
Contact Person Name			
Job Title		Department	

2. Application (Please check(V) for your choice)

Category	
Exhibition	Fee (KRW)
<input type="checkbox"/> 1 Stand	2,500,000
<input type="checkbox"/> 2 Stands	4,750,000
<input type="checkbox"/> 3 Stands	6,750,000
<input type="checkbox"/> 4 Stands	8,500,000

3. Payment Method (Bank Transfer Only)

Account Holder	Korean Institute of Electromagnetic Engineering and Science (KOR) (사)한국전자파학회
Account Number	208-017491-01-209
Bank Name	Industrial Bank of Korea
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Date _____

Signature _____